

Serial No. : 2012-0226

DATE: 2012/02/22

ITEM:	CRYSTAL RESONATOR
TYPE :	DSX211G
NOMINAL FREQUENCY:	38. 400MHz
SPEC No. :	1ZZCAA38400AB0B

	RECEIPT
DATE	
RECEIVED	(signature)
	(name)

General Manufacturer of Quartz Devices

Please acknowledge receipt of this specification

by signing and returning a copy to us.

# DAISHINKU CORP.

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C.ENG.

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#### 1. ELECTRICAL CHARACTERISTICS

(This test shall be performed under the conditions of temp.at 25 ± 3°C, Relative Humidity 60% max.)

(1) NOMINAL FREQUENCY 38.400000 MHz

(2) OVERTONE ORDER Fundamental

(3) LOAD CAPACITANCE(CL) 12.0 pF

(4) FREQUENCY TOLERANCE  $\pm 10$  ppm max. (at +25  $\pm$  3 °C)

(5) DRIVE LEVEL 10  $\pm$  2  $\mu$ W

(6) SERIES RESISTANCE 60  $\Omega$  max. (at Series)

(7) OPERATING TEMPERATURE RANGE -30 ~ +85 °C

(8) FREQUENCY CHARACTERISTICS ±15 ppm max. / -30 ~ +85 °C (ref. to +25 °C)

OVER TEMPERATURE

(9) SHUNT CAPACITANCE 2pF max.

(10) INSULATION RESISTANCE 500M $\Omega$  min. / DC 100  $\pm$  15V

(11) STORAGE TEMPERATURE RANGE -40 ~ +85 °C

2. CONSTRUCTION

(1) DIMENSIONS AND MARKING Refer to 4.

3. OTHER SPECIFICATIONS

(1) EMBOSS CARRIER TAPE & REEL Refer to 5.

(2) PACKING Refer to 6.

(3) REFLOW CONDITIONS (REFERENCE) Refer to 7.

(4) LAND PATTERN (REFERENCE) Refer to 8.

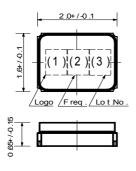
(5) RELIABILITY SPECIFICATION Refer to 9.~11.

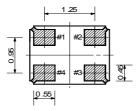
(6) OTHER

HANDLING INSTRUCTIONS Refer to 12.

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### 4. DIMENSIONS AND MARKING





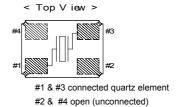


Figure-1

unit : mm Tolerance : ±0.1

Logo(1) and Nominal Frequency (2) should be printed as follows by producing district

Made in INDONESIA  $\longrightarrow$  Spec. No.: 1ZZCAA38400AB0B , Logo :  $\underline{D}$  , Frequency: 38

\* Made in INDONESIA : Under Bar with D

Nominal Frequency (2) = Mark two digits from upper decimal point (ex. 38.400000 MHz ----> 38)

Manufacturing lot No.(3)

Year: The last digit of the year

week : We gave the sequence of week numbers 01(first week) for production date.

there are starting from 1st of Jan. However, add '0' figure to the first week during the nine weeks.

The week means are from Sunday to Saturday.

(ex. 2012/2/22 ---> 208 )

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### 5. EMBOSS CARRIER TAPE & REEL

### (1) Dimensions of embossed carrier tape

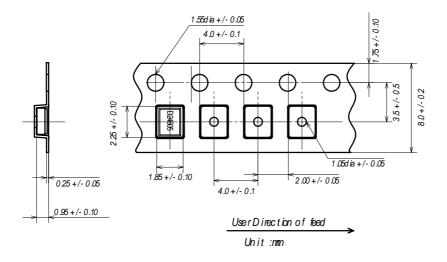


Figure-2

### (2) Dimensions of tape reel

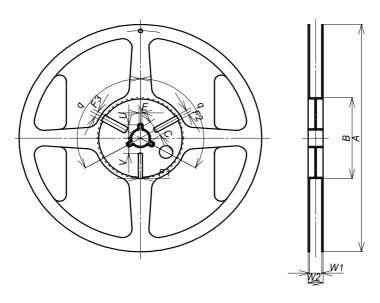


Figure-3

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(UNIT:mm)

				(CIVIT.IIIII)
Products				DSX211G
Item		Mark	Dimensions Angle	
	Diameter		Α	180 dia. +0.0 / -3.0
Flange	Inside	of Frange	W1	9.0 ± 0.3
	Outside	e of Frange	W2	11.4 ± 1.0
	Inside	Diameter	В	60 dia. +1.0 / -0.0
		Width	F1	3.0 ± 0.2
Center Core	Center Core Slit		F2	4.0 ± 0.2
			F3	5.0 ± 0.2
		Length	V	11.9 +0.5 / -0.0
		Angle	q	120°
	Spindle Diameter		С	13 dia. ± 0.2
		Width	E	2.0 ± 0.5
	Key Seats	Length	U	10.5 ± 0.4
		Angle	q	120°
			<u> </u>	1

(3) Storage condition

Temperature : +40 °C max. Relative Humidity : 80% max.

( It is a guaranteed term because it obtains an excellent soldering: 6 months)

(4) Standard packing quantity

3,000 pcs/reel

(5) Material of the tape

Tape	Material
Carrier tape	Polystyrene+Carbon
Cover tape	Polyester

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### (6) Label contents

Type

Our specification No.

Your Part No.

Lot No.

Nominal Frequency

Quantity

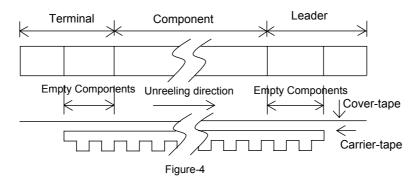
Our Company Name

**Producting Country** 

Stick a label on the each reel.

### (7) Taping dimension

	Cover-tape	The length of cover-tape in the leader is more than 400mm
Leader		including empty embossed area.
	Carrier-tape	After all products were packaged, must remain more than twenty pieces
		or 400mm empty area, which should be sealed by cover-tape.
	Cover-tape	The tip of cover-tape shall be fixed temporary by paper tape and roll around
Terminal		the core of reel one round.
	Carrier-tape	The empty embossed area which are sealed by cover-tape must remain
		more than 40mm.



### (8) Joint of tape

The carrier-tape and cover-tape should not be jointed.

### (9) Release strength of cover tape

It has to between  $0.1 \sim 0.7N$  under following condition.

Pulling direction 165 ~ 180 ° Speed 300mm/min. Otherwise unless specified.

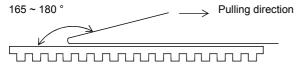


Figure-5

Other standards shall be based on JIS C 0806 <sub>-1990</sub>.

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### 6. PACKING

### (1) STORAGE METHOD

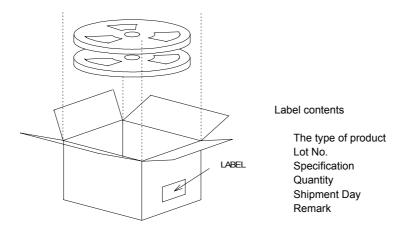


Figure-6

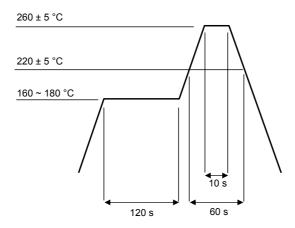
### (2) BOX SIZE

From lot size packingsize shall be changed. In the upper and lower part and the opening in box it shall be protected products using aircushion sheets.

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### 7. REFLOW CONDITIONS (REFERENCE)

During the solder reflow process, please complete within following temperature, period. Reflow soldering shall be allowed only 2 times.

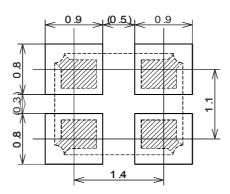


Total time: 200 s max.

Figure-7

HANDSOLDERING METHOD:  $350 \pm 10\,^{\circ}\text{C}$ , 3+1/-0s Each terminal once (Please take care so that a soldering iron should not touch a product directly.)

### 8. LAND PATTERN (REFERENCE)



unit: mm

Figure-8

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#### 9. MECHANICAL ENDURANCE

### (1) SHOCK (ACCELERATION)

After the following test,parts shall conform specification 11.B. 1000m/s<sup>2</sup> by 6ms X,Y,Z each axis (6 directions), 3cycles

### (2) SHOCK (MOUNTING DROP)

After the following test, parts shall conform specification 11.B.

3cycles(18times) drop from 150 cm heights to concrete.

Further, parts shall be solderd on substrate, fixed Aluminum materials (about 100g).

Substrate materials: Glass Epoxy

1 cycle : each 1 times of 6 directions

#### (3) VIBRATION

After the following test, parts shall conform specification 11.B.

and no abnormal appearance shall be observed.

Frequency of Vibration : 10 ~ 500 ~ 10 Hz

Amplitude(p-p) : Sine waves of 1.5mm or 100m/s<sup>2</sup>

Cycle : 11min Vibration axis : X.Y.Z

Vibration period : 2 h for each axis

#### (4) SEAL

Less than 2.0×10<sup>-9</sup> Pa m<sup>3</sup>/s. by Helium leak detector. Also, no serial bubble is observed by Fluorocarbon tests.

#### (5) SOLDERABILITY

After the following test, more than 95% of terminal shall be covered by new solder.

 $3 \pm 0.5$  s dip in  $245 \pm 5$  °C solder.

(Solder composition: Sn-3Ag-0.5Cu) (Use rosin type flux for solder.)

### (6) RESISTANCE TO SOLDERING HEAT (REFLOW)

48 h past at room temperature from following test,parts shall conform specification 11.B. perform the attached Reflow conditions to reference.

### (7) RESISTANCE TO SOLDERING HEAT (HAND SOLDERING METHOD)

48 h past at room temperature from following test,parts shall conform specification 11.B.  $350 \pm 10^{\circ}C$ , 3+1/-0s Each terminal once.

#### (8) SUBSTRATE BENDING

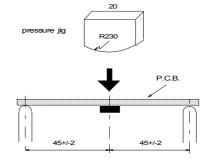
After the following test, parts shall conform specification 11.B.

and no abnormality shall be observed in external appearance and sealing

tightnen and others shall be based on ET-7403 of EIAJ.

Mount the specimen on substrate.

Apply the following pressure



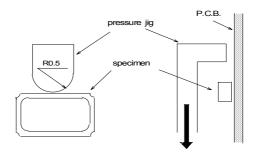
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### (9) SHEAR

After the following test, parts shall conform specification 11.B. and no abnormality shall be observed in external appearance and sealing tightness and others shall be based on ET-7403 of EIAJ.

Mount the specimen on substrate.

Apply the following pressure



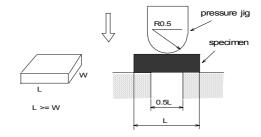
### (10) BODY STRENGTH

After the following test,parts shall conform specification 11.B. and no abnormality shall be observed in external appearance and sealing tightness and others shall be based on ET-7403 of EIAJ.

Mount the specimen on substrate.

Apply the following pressure

Weight : 5 NHours :  $10 \pm 1 \text{ s}$ Direction : see right figure



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### 10. ENVIRONMENTAL ENDURANCE

### (1) LOW TEMPERATURE

2 h past at room temperature after following test, parts shall conform specification 11.B. 240 h ,  $\,$  -40  $\pm$  3  $^{\circ}\text{C}.$ 

### (2) HUMIDITY

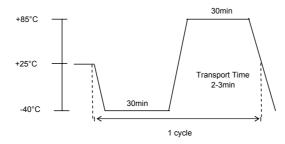
2 h past at room temperature after following test, parts shall conform specification 11.C. 240 h +85  $\pm$  2 °C , relative humidity 85  $\pm$  5%.

### (3) HIGH TEMPERATURE

2 h past at room temperature after following test, parts shall conform specification 11.C. 240 h ,  $+85 \pm 2$  °C.

### (4) TEMPERATURE CYCLE

2 h past at room temperature after 25 cycles of followingtest, parts shall conform specification 11.C.



### 11. SPECIFICATION

Frequency Variation and Equivalent Resistance shall be within Table below after the reliability test.

Spec.	Frequency Variation	Equivalent Resistance
Α	±2ppm	±15 % or 2.0 Ω max. (Use larger specification)
В	±5ppm	±20 % or 3.0 Ω max. (Use larger specification)
С	±10ppm	±20 % or 3.0 Ω max. (Use larger specification)
D	±20ppm	±25 % or 10.0 Ω max. (Use larger specification)

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#### 12. DSX211G TYPE QUARTZ CRYSTAL HANDLING INSTRUCTIONS

#### (1) SOLDERING

Please perform the attached Reflow conditions to reference within 2 times.

#### (2) MOUNT

Crystal products are designed to be compatible with automatic mounting. Be sure to have a mounting test in advance by using the actual mounting machine and check that the characteristics of the products are not damaged by the automatic mounting.

In the process where the boad is warped, such as board separation process, be careful that the warping does not influence the characteristics

and soldering of crystal products.

Since mounting by Ultrasonic welding and processing have a possibility of an excessive vibration spreading inside a crystal resonator and becoming the cause of characteristic deterioration and not oscillating, it does not recommend.

#### (3) WASHING

About use of the washing liquid of a basin system, an alcoholic system, and a chlorofluorocarbon-replacing material system, it is checking that it is satisfactory. However please consult in advance about other washing liquid. Although the check about ultrasonic washing is performed, since it is an examination with a simple substance, the check for the second time by the use state is recommended.

#### (4) THE CAUTIONS ON USE

The piece of crystal it is processed very smaller than the conventional thing inside DSX211G series crystal unit may be damaged,

if excessive excitation electric power is applied.

Please use it below with the value specified on a catalog and specifications.

Please refrain from forming patterns between crystal land pattern's since there is a possibility to cause crack in base.

If the temperature is higher than 280  $^{\circ}\text{C},$  there is a possibility for the sealing glass to remelt.

Avoid using the product at temperature higher than specified.

### (5) HANDLING OF A PRODUCT

DSX211G series has sufficient intensity to fall and vibration. However when too much shock is added according to a certain cause, the use after a characteristic check is recommended.

#### (6) STORAGE

Since the soldering nature of a terminal may be degraded, please avoid storage in high temperature and a humid place. Please keep it in the place which direct rays do not hit and dew condensation does not generate.

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## 2012-0226 REVISION RECORD

Rev.No	Date	Reason	Contents	Approved	Checked	Drawn
-	2012/02/22	-	The first edition.	T.Okishio	Y.Maeda	M.Shikai